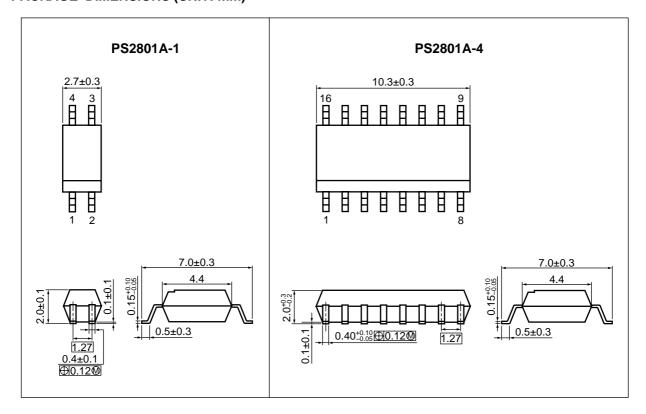
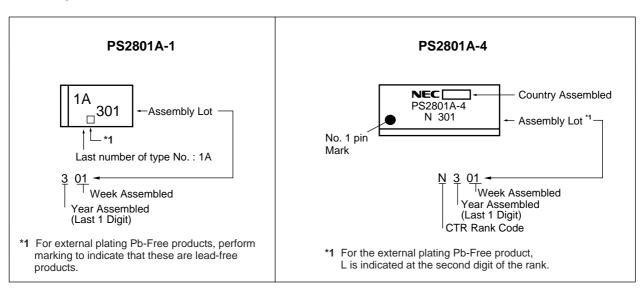
PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE



★ ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS2801A-1	PS2801A-1	Solder contains	50 pcs (Tape 50 pcs cut)	Standard products	PS2801A-1
PS2801A-1-F3	PS2801A-1-F3	lead	Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2801A-1-F4	PS2801A-1-F4				
PS2801A-4	PS2801A-4		Magazine Case 45 pcs		PS2801A-4
PS2801A-4-F3	PS2801A-4-F3		Embossed Tape 2 500 pcs/reel		
PS2801A-4-F4	PS2801A-4-F4				
PS2801A-1-V	PS2801A-1-V		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	PS2801A-1
PS2801A-1-V-F3	PS2801A-1-V-F3		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2801A-1-V-F4	PS2801A-1-V-F4			Approved (Option)	
PS2801A-4-V	PS2801A-4-V		Magazine Case 45 pcs		PS2801A-4
PS2801A-4-V-F3	PS2801A-4-V-F3		Embossed Tape 2 500 pcs/reel		
PS2801A-4-V-F4	PS2801A-4-V-F4				
PS2801A-1	PS2801A-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2801A-1
PS2801A-1-F3	PS2801A-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL approved)	
PS2801A-1-F4	PS2801A-1-F4-A				
PS2801A-4	PS2801A-4-A		Magazine Case 45 pcs		PS2801A-4
PS2801A-4-F3	PS2801A-4-F3-A		Embossed Tape 2 500 pcs/reel		
PS2801A-4-F4	PS2801A-4-F4-A				
PS2801A-1-V	PS2801A-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	PS2801A-1
PS2801A-1-V-F3	PS2801A-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2801A-1-V-F4	PS2801A-1-V-F4-A			Approved (Option)	
PS2801A-4-V	PS2801A-4-V-A		Magazine Case 45 pcs		PS2801A-4
PS2801A-4-V-F3	PS2801A-4-V-F3-A		Embossed Tape 2 500 pcs/reel		
PS2801A-4-V-F4	PS2801A-4-V-F4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS2801A-1	PS2801A-4	
Diode	Forward Current (DC)	lF	30		mA
	Reverse Voltage	VR	6		V
	Power Dissipation Derating	⊿P₀/°C	0.6	0.8	mW/°C
	Power Dissipation	PD	60	80	mW/ch
	Peak Forward Current*1	IFP	0.5		Α
Transistor	Collector to Emitter Voltage	Vceo	70		V
	Emitter to Collector Voltage	VECO		5	V
	Collector Current	lc	3	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.	.2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage *2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	-55 to +100		°C
Storage Temperature		T _{stg}	-55 to +150		°C

^{*1} PW = 100 μ s, Duty Cycle = 1 %

^{*2} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I _F = 5 mA		1.2	1.4	V
	Reverse Current	lR	V _R = 5 V			5	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	ICEO	Vce = 70 V, I _F = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)*1	CTR	IF = 5 mA, VcE = 5 V	50		400	%
	Collector Saturation Voltage	VCE (sat)	IF = 10 mA, Ic = 2 mA		0.13	0.3	V
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time *2	t r	$Vcc = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ RL} = 100 \Omega$		5		μS
	Fall Time *2	tf			7		

*1 CTR rank

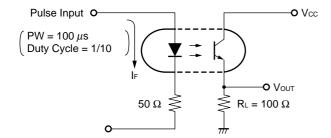
PS2801A-1

N: 50 to 400 (%) P: 150 to 300 (%) L: 100 to 300 (%)

PS2801A-4

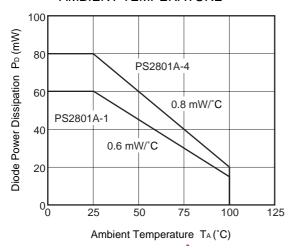
N: 50 to 400 (%)

*2 Test circuit for switching time

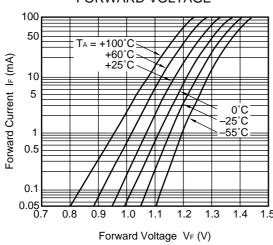


TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)

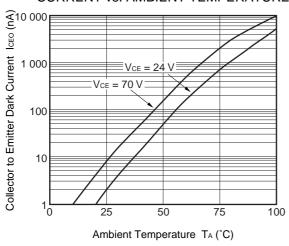
DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



FORWARD CURRENT vs. FORWARD VOLTAGE

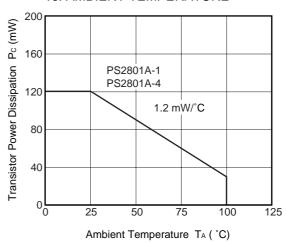


COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

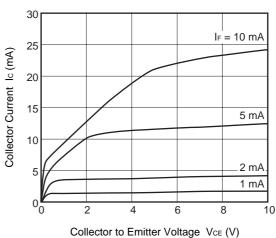


Remark The graphs indicate nominal characteristics.

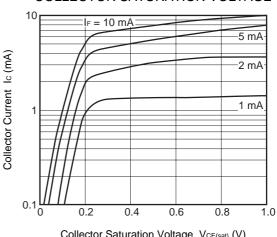
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. **COLLECTOR TO EMITTER VOLTAGE**

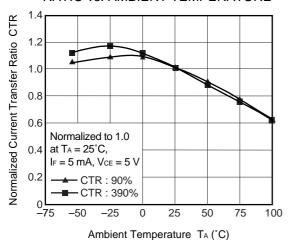


COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

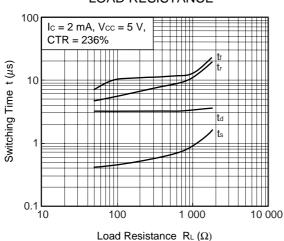


Collector Saturation Voltage VcE(sat) (V)

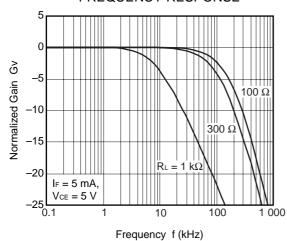
★ NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

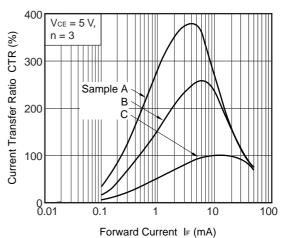


FREQUENCY RESPONSE

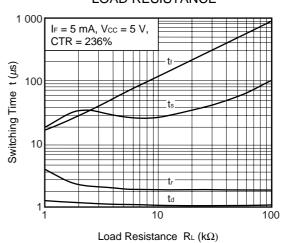


Remark The graphs indicate nominal characteristics.

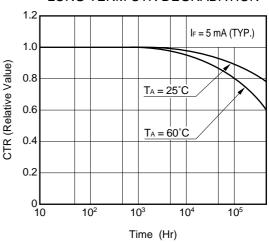
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



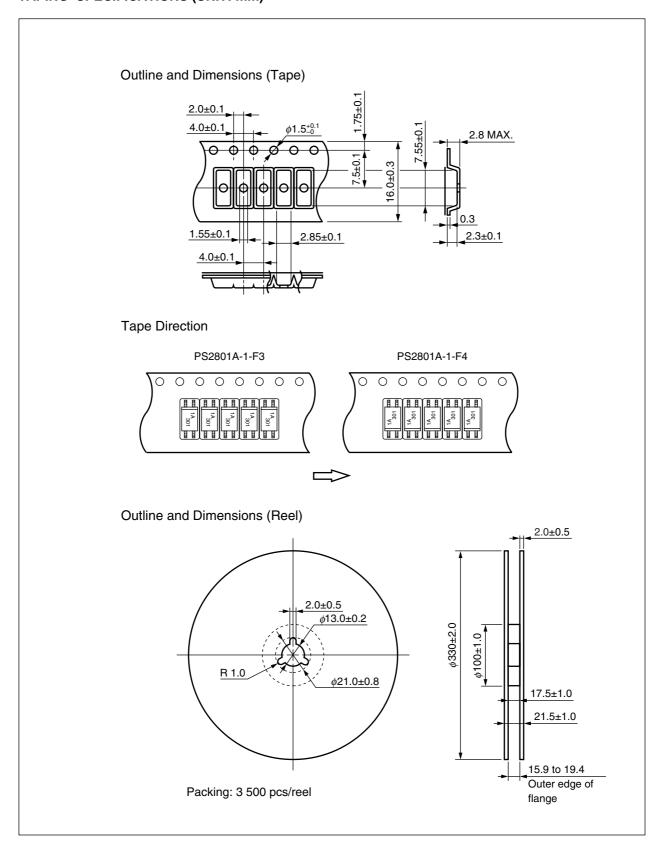
SWITCHING TIME vs. LOAD RESISTANCE

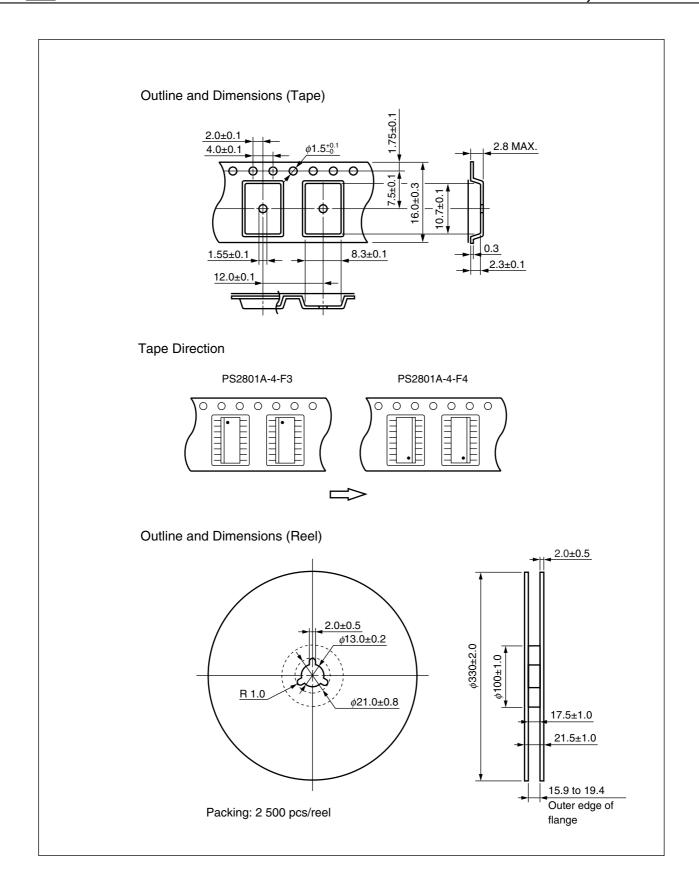


LONG TERM CTR DEGRADATION



TAPING SPECIFICATIONS (UNIT: mm)





NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

Peak reflow temperature
260°C or below (package surface temperature)

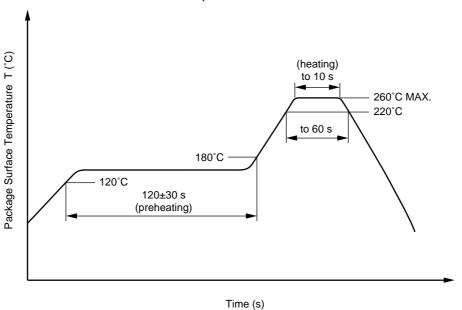
Time of peak reflow temperature
Time of temperature higher than 220°C
60 seconds or less

Time to preheat temperature from 120 to 180°C 120±30 s
Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Flux
Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below
Time (each pins) 3 seconds or less

Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- **2.** Avoid storage at a high temperature and high humidity.

11



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500 Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration in CEL	on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not De	etected	
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.